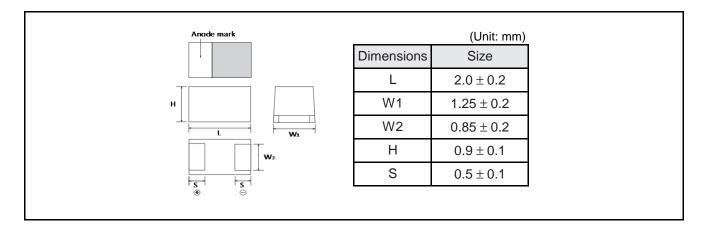
## Conductive polymer chip capacitors (New Bottom surface electrode type: Extra Large capacitance) TCSO Series PL Case

Datasheet

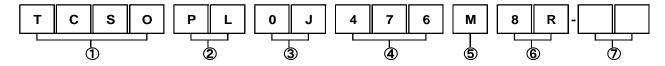
#### Features

- 1) Conductive polymer used at the cathode for ultra-low ESR.
- 2) New package structure results in the largest capacitance.
- 3) Compact, low profile, ultra-high capacitance contributes to smaller, thinner sets with greater functionality.
- 4) Conductive polymer has a self-healing function that prevents failure, resulting in safe, high reliability operation.

#### Dimensions



### ● Part No. Explanation



- ① Series name TCSO
- ② Case style

PL: 2012-10 (0805) Low profile size

3 Rated voltage

CODE	Rated voltage (V)
0J	6.3
1A	10
1E	25

- 4 Nominal capacitance
  - Nominal capacitance in pF in 3 digits: 2 significant figures followed by the figure representing the number of 0's.
- ⑤ Capacitance tolerance

M: ±20%

6 Taping

8: Tape width

R: Positive electrode on the side opposite to sprocket hole

⑦ Discrimination code

<sup>\*</sup>This specification has possibility of charge, due to underdevelopment product. Please ask for latest specification to our sales.

### Rated table

 $(\mathsf{ESR}\,:\mathsf{m}\,\Omega)$ 

			(2011 : 11132)			
Capacitance	Rated voltage (V.DC)					
(µF)	6.3	10	25			
4.7 (475)			500			
22 (226)		200				
33 (336)		☆200				
47 (476)	150 / 200					
68 (686)	<b>☆</b> 150 / <b>☆</b> 200					

## Marking

The indications listed below should be given on the surface of a capacitor.

- (1) Polarity: The polarity should be shown by □ bar. (on the anode side)
- (2) Rated DC voltage: A voltage code is shown as below table.
- (3) Capacitance : A capacitance code is shown as below table.

Voltage Code	Rated DC Voltage (V)
j	6.3
А	10
Е	25

Capacitance Code	Nominal Capacitance ( $\mu$ F)
S	4.7
j	22
n	33
S	47
W	68

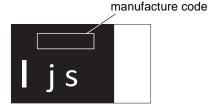
Visual typical example

voltage code and capacitance code are variable with parts number.

[PL case]

EX.)

(1) voltage code (2) capacitance code



## Characteristics

ltem Performance  Departing Temperature -55°C to +105°C			itions (based on JIS C 510									
Operating Temperature  Maximum operating temperature			+105°C			Voltage reduction when	n temperature exceeds +8	35°C				
with no voltage of	• .	+85°C										
Rated voltage (V	/.DC)	2.5	4	6.3	10	at 85°C						
Category voltage	e (V.DC)	2	3.2	5	8	at 105°C						
Surge voltage (V	/.DC)	3.2	5	8	13	at 85°C						
DC Leakage cur	rent	Shall be	satisfied t	the value	on "	As per 4.9 JIS C 5101-	-1					
		Standard	l list "			As per 4.5.1 JIS C 510 Voltage : Rated voltage						
Capacitance tole	erance	Shall be	satisfied a	allowance	e range.	As per 4.7 JIS C 5101-	-1					
		±20%				As per 4.5.2 JIS C 510						
						Measuring frequency: Measuring voltage: 0.5						
							equivalent series circuit					
Tangent of loss	angle (Df, tan δ)		satisfied t	the voltag	ge on "	As per 4.8 JIS C 5101-						
		Standard	l list "			As per 4.5.3 JIS C 510 Measuring frequency:						
						Measuring voltage : 0.5						
						Measuring voltage 10.50 miles 11.50 be						
ESR		Shall be Standard	satisfied t	the value	on "	As per 4.10 JIS C 510						
		Standard	HISL			As per 4.5.4 JIS C 5101-3 Measuring frequency : 100±10kHz						
						Measuring voltage: 0.5Vrms or less						
	T.					Measuring circuit : DC equivalent series circuit						
Resistance to Soldering heat	Appearance		ould be n lity. The i	•		As per 4.14 JIS C 510 <sup>o</sup> As per 4.6 JIS C 5101-						
Coldoning Hour		be clear.	-	naioanon	o onodia	Dip in the solder bath	·					
	L.C.	Less tha	n 300% o	f initial lin	nit	Solder temp.: 240±5 Duration: 10±0.5s Repetition 1 After the specimens, leave it at room temperature for over 24h and then measure						
	⊿c/c	Within ±2	20% of ini	tial value								
	Df (tan δ)	Less tha	n 300% o	f initial lin	nit	the sample.						
Temperature	Appearance		ould be n	•		As per 4.16 JIS C 510						
cycle		abnormality. The indications should be clear.				As per 4.10 JIS C 5101-3 Repetition: 5 cycles						
							without discontinuation.					
							Temp.	Time				
	L.C.	Less tha	n 1000%	of initial li	imit	1	−55±3°C	30±3min.				
						2	Room temp.	3min. or less				
	42.45					3	105±2°C	30±3min.				
	⊿c/c	Within ±2	20% of ini	tial value		4	Room temp.	3min. or less				
						After the specimens, le the sample.	eave it at room temperatur	e tor over 24h and then n	neasure			
	Df (tan δ)	Less tha	n 300% o	f initial lin	nit	1						
Moisture resistance	Appearance	There should be no significant abnormality. The indications should be clear.					1-3 le under such atmospheric	•				
	L.C.	Less than 300% of initial limit			nit	humidity are 40±2°C and 90 to 95% RH, respectively, for 500±12h leave it at room temperature for over 24h and then measure the sample.						
	L.O.					temperature for over 2	4n and then measure the	samble.				
	<u>⊿</u> c / c	Within +	30/–20%	of initial v	alue	temperature for over 24	4n and then measure the	sample.				

	em	Performance	Test conditions (based on JIS C 5101–1 and JIS C 5101–3)					
Temperature Temp.		–55°C	As per 4.29 JIS C 5101-1					
Stability	⊿c/c	Within 0/–20% of initial value	As per 4.13 JIS C 5101-3					
	Df (tan δ)	Shall be satisfied the value on " Standard list "						
	L.C.	-						
	Temp.	+105°C						
	⊿c/c	Within +50/0% of initial value	7					
	Df (tan δ)	Shall be satisfied the value on " Standard list "	7					
	L.C.	Less than 1,000% of initial value						
Surge voltage	Appearance	There should be no significant abnormality. The	As per 4.26JIS C 5101-1 As per 4.14JIS C 5101-3					
	1.0	indications should be clear.	Apply the specified surge voltage via the serial resistance of $1k\Omega$ ever $5\pm0.5$ min. for $30\pm5$ s. each time in the atmospheric condition of $85\pm$ $2^{\circ}$ C. Repeat this procedure 1,000 times.					
	L.C.	Less than 200% of initial limit						
	⊿c/c	Within ±20% of initial value	After the specimens, leave it at room temperature for over 24h and					
	Df (tan δ)	Less than 200% of initial limit	then measure the sample.					
Loading at High temperature	Appearance	There should be no significant abnormality. The indications should be clear.	As per 4.23 JIS C 5101-1 As per 4.15 JIS C 5101-3					
	L.C.	Less than 400% of initial limit	<ul> <li>After applying the rated voltage for 1000+72/0 h without discontinuation via the serial resistance of 3Ω or less at a temperature of 85±2°C,</li> </ul>					
	⊿c/c	Within ±20% of initial value	leave the sample at room temperature / humidity for over 24h and					
	Df (tan δ)	Less than 300% of initial limit	measure the value.					
Terminal strength	Capacitance	The measured value should be stable.	As per 4.35 JIS C 5101-1					
			As per 4.9 JIS C 5101-3  A force is applied to the terminal until it bends to 1mm and by a					
			prescribed tool maintains the condition for 5s.					
	Appearance	There should be no significant abnormality.	(See the figure below)					
			(Unit: mm)					
			F (Apply force)					
			R230					
			1 1					
			thickness=1.6mm					
			45 45					
Adhesiveness		The terminal should not come off.	As per 4.34 JIS C 5101-1 As per 4.8 JIS C 5101-3					
			Apply force of 5N in the two directions shown in the figure below for 10					
			±1s after mounting the terminal on a circuit board.					
			product					
			Apply force					
			a circuit board					
Dimensions		Refer to "External dimensions"	Measure using a caliper of JIS B 7507 Class 2 or higher grade					
Resistance to solvents		The indication should be clear.	As per 4.32 JIS C 5101-1					
			As per 4.18 JIS C 5101-3  Dip in the isopropyl alcohol for 30±5s, at room temperature.					
			7 7					
Solderability		3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3					
		covered with the new solder.	As per 4.7 JIS C 5101-3 Dip speed : 25±2.5mm / s					
			Pre-treatment (accelerated aging):					
			Leave the sample on the boiling distilled water for 1 h. Solder temp. : 245±5°C					
			Duration: 3±0.5s					
			Solder: M705					
			Flux: Rosin 25% IPA 75%					
Vibration	Capacitance	Measure value should not fluctuate during the	As per 4.17 JIS C 5101-1 Frequency : 10 to 55 to 10Hz/min. Amplitude : 1.5mm					
V 101 GUIOTT		measurement.						
· ioranon			→Amplitude: 1.5mm					
	Appearance	There should be no significant abnormality.	Amplitude: 1.5mm Time: 2h each in X and Y directions.					

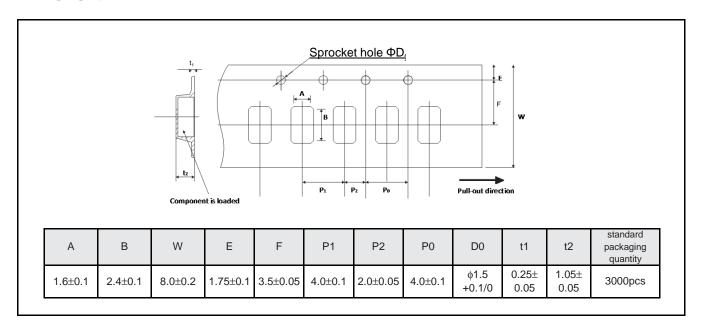


## Standard products list

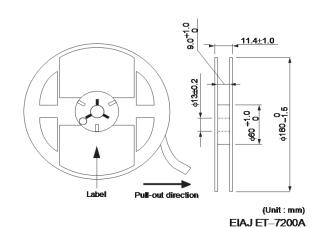
Part No.	Rated voltage 85°C	Category voltage 105°C	Surge voltage 85°C	Cap. 120Hz	Toleranc e	Leakage current 25°C	Df 120Hz (%)		ESR 100kHz	
	(V)	(V)	(V)	(μF)	(%)	1WV.5mi n (μA)	−55°C	25°C	105°C	(mΩ)
TCSO PL 0J 476 M8R -ZF1	6.3	5	8	47	±20	29.7	15	15	20	150
TCSO PL 0J 476 M8R -ZD1	6.3	5	8	47	±20	29.7	15	15	20	200
* TCSO PL 0J 686 M8R -ZF1	6.3	5	8	68	±20	129.0	15	15	20	150
* TCSO PL 0J 686 M8R -ZD1	6.3	5	8	68	±20	129.0	15	15	20	200
TCSO PL 1A 226 M8R	10	8	13	22	±20	22.0	15	15	20	200
* TCSO PL 1A 336 M8R -ZD1	10	8	13	33	±20	33.0	15	15	20	200
TCSO PL 1E 475 M8R -ZT1	25	20	29	4.7	±20	11.8	10	10	15	500

<sup>\*</sup> Under development

## Packaging specifications



#### Reel dimensions



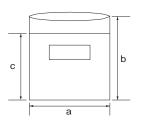
## ●Damp proof package

①One reel is packed in aluminum bag.

The size of aluminum bag is 240(a) x 250(b)mm.

The size up to 230(c)mm is to zipper.

- ②A desiccant is packed with a reel.
- 3The aluminum bag is heat-sealed.
- (4) The label of the same as the label on the reel is placed on the aluminum bag.



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#### **Precaution on using ROHM Products**

Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSIII
CLASSIV	CLASSIII	CLASSⅢ	CLASSIII

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  - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

#### **Precaution for Product Label**

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

#### **Precaution for Disposition**

When disposing Products please dispose them properly using an authorized industry waste company.

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